



SPECIFICATION

(Reference sheet)

• Supplier : Samsung electro-mechanics • Samsung P/N : CL31C151KBCNBNC

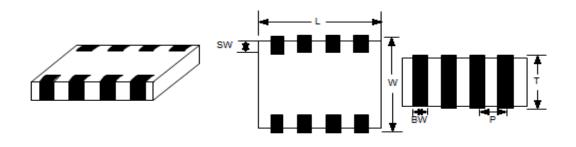
• Product : Multi-layer Ceramic Capacitor • Description : CAP, 150 pF, 50V, ±10%, COG, 1206

A. Samsung Part Number

<u>CL</u> <u>31</u> <u>C</u> <u>151</u> <u>K</u> <u>B</u> <u>C</u> <u>N</u> <u>B</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor								
2	Size	1206 (inch code)	L: 3.20	± 0.15	mm	W:	1.60 ±	0.15	mm	
3	Dielectric	COG	8	Inner elec	trode		Ni			
4	Capacitance	150 pF		Terminati	on		Cu			
(5)	Capacitance	±10 %		Plating			Sn 100%	6	(Pb Free)	
	tolerance		9	Product			Array (4	-elem	ient)	
6	Rated Voltage	50 V	10	Special			Reserve	ed for	future use	
7	Thickness	0.85 ± 0.15 mm	11)	Packaging	g		Cardboa	ard Ty	/pe, 7" reel	

B. Structure and dimension



Samsung P/N	L	W	Т	BW	SW	Р
CL31C151KBCNBNC	3.20 ± 0.15	1.60 ± 0.15	0.85 ± 0.15	0.40 ± 0.20	0.30 ± 0.15	0.80 ± 0.20

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition				
Capacitance	Within specified tolerance	1Mb±10% / 0.5±5Vrms				
Q	1,000 min.	*A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1hour and maintained in ambient air for 24±2 hours.				
Insulation	10,000Mohm or 500Mohm× <i>μ</i> F	Rated Voltage 60~120 sec.				
Resistance	Whichever is smaller					
Appearance	No abnormal exterior appearance	Microscope (×10)				
Withstanding	No dielectric breakdown or	300% of the rated voltage				
Voltage	mechanical breakdown					
Temperature	COG					
Characterisitcs	(From -55℃ to 125℃, Capacitance change	should be within ±30PPM/℃)				
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.				
of Termination	terminal electrode					
Bending Strength	Capacitance change :	Bending to the limit (1 ^{mm})				
	within ±5% or ±0.5pF whichever is larger	with 1.0mm/sec.				
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder				
	is to be soldered newly	245±5℃, 3±0.3sec.				
		(preheating : 80~120 ℃ for 10~30sec.)				
Resistance to	Capacitance change :	Solder pot : 270±5℃, 10±1sec.				
Soldering heat	within ±2.5% or ±0.25pF whichever is larger					
	Tan δ, IR : initial spec.					
Vibration Test	Capacitance change :	Amplitude : 1.5mm				
	within ±2.5% or ±0.25pF whichever is larger	From 10Hz to 55Hz (return : 1min.)				
	Tan δ, IR : initial spec.	2hours × 3 direction (x, y, z)				
Moisture	Capacitance change :	With rated voltage				
Resistance	within ±7.5% or ±0.75pF whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs				
	Q: 200 min					
	IR : 500Mohm or 25Mohm × <i>μ</i> F					
	Whichever is smaller					
High Temperature	Capacitance change :	With 200% of the rated voltage				
Resistance	within ±3% or ±0.3pF whichever is larger	Max. operating temperature				
	Q: 350 min	1,000+48/-0hrs				
	IR: 1,000Mohm or 50Mohm × μF					
	Whichever is smaller					
Temperature	Capacitance change :	1 cycle condition				
Cycling	within ±2.5% or ±0.25pF whichever is larger	Min. operating temperature → 25°C				
	Tan δ, IR : initial spec.	→ Max. operating temperature → 25°C				
	·					
		5 cycle test				
	L	1 -				

^{**} The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260±5°C, 30sec.)

Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

- Disclaimer & Limitation of Use and Application -

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- Military equipment
- 5 Disaster prevention/crime prevention equipment
- Any other applications with the same as or similar complexity or reliability to the applications set forth above.